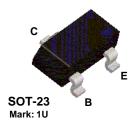


PN2484

MMBT2484





NPN General Purpose Amplifier

This device is designed for low noise, high gain, general purpose amplifier applications at collector currents from 1μ to 50 mA. Sourced from Process 07. See 2N5088 for characteristics.

Absolute Maximum Ratings*

TA = 25°C unless otherwise noted

Symbol	Parameter	Value	Units
V_{CEO}	Collector-Emitter Voltage	60	V
V _{CBO}	Collector-Base Voltage	60	V
V _{EBO}	Emitter-Base Voltage	5.0	V
Ic	Collector Current - Continuous	100	mA
T _J , T _{stg}	Operating and Storage Junction Temperature Range	-55 to +150	°C

^{*}These ratings are limiting values above which the serviceability of any semiconductor device may be impaired.

- These ratings are based on a maximum junction temperature of 150 degrees C.
 These are steady state limits. The factory should be consulted on applications involving pulsed or low duty cycle operations.

Thermal Characteristics

TA = 25°C unless otherwise noted

Symbol	Characteristic	Max		Units
		PN2484	*MMBT2484	
P _D	Total Device Dissipation	625	350	mW
	Derate above 25°C	5.0	2.8	mW/°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	357	°C/W

^{*}Device mounted on FR-4 PCB 1.6" X 1.6" X 0.06."

NPN General Purpose Amplifier (continued)

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		aı v	ма	ıaı	LEI	ISH G

TA = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Max	Units
OFF CHAI	RACTERISTICS				
BV _{CBO}	Collector-Base Breakdown Voltage	$I_C = 10 \mu A, I_B = 0$	60		V
BV _{CEO}	Collector-Emitter Breakdown Voltage*	I _C = 10 mA, I _E = 0	60		V
BV _{EBO}	Emitter-Base Breakdown Voltage	$I_C = 10 \mu A, I_E = 0$	6.0		V
I _{CBO}	Collector Cutoff Current	$V_{CB} = 45 \text{ V}, I_E = 0$ $V_{CB} = 45 \text{ V}, I_E = 0, T_A = 150^{\circ}\text{C}$		10 10	nA μA
I _{EBO}	Emitter Cutoff Current	$V_{EB} = 5.0 \text{ V}, I_{C} = 0$		10	nA

ON CHARACTERISTICS

h _{FE}	DC Current Gain	$\begin{split} I_C &= 1.0 \; \mu\text{A}, \; V_{CE} = 5.0 \; V \\ I_C &= 10 \; \mu\text{A}, \; V_{CE} = 5.0 \; V \\ I_C &= 100 \; \mu\text{A}, \; V_{CE} = 5.0 \; V \\ I_C &= 100 \; \mu\text{A}, \; V_{CE} = 5.0 \; V \\ T_A &= -55^\circ\text{C} \\ I_C &= 500 \; \mu\text{A}, \; V_{CE} = 5.0 \; V \\ I_C &= 1.0 \; \text{mA}, \; V_{CE} = 5.0 \; V \\ I_C &= 10 \; \text{mA}, \; V_{CE} = 5.0 \; V^* \end{split}$	30 100 175 20 200 250	500 800	
V _{CE(sat)}	Collector-Emitter Saturation Voltage	$I_C = 1.0 \text{ mA}, I_B = 0.1 \text{ mA}$		0.35	V
$V_{BE(on)}$	Base-Emitter On Voltage	$I_C = 100 \mu\text{A}, V_{CE} = 5.0 \text{V}$	0.5	0.7	V

SMALL SIGNAL CHARACTERISTICS

C_{obo}	Output Capacitance	V _{CB} =5.0 V, f = 140 kHz	6.0	pF
C _{ibo}	Input Capacitance	V _{EB} = 0.5 V, f = 140 kHz	6.0	pF
NF	Noise Figure	$I_C = 10 \mu A$, $V_{CE} = 5.0 \text{ V}$, $R_S = 10 \text{k,f} = 1.0 \text{ kHz,BW} = 200 \text{ Hz}$	3.0	dB

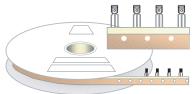
^{*}Pulse Test: Pulse Width \leq 300 μs , Duty Cycle \leq 3.0%

TO-92 Tape and Reel Data FAIRCHILD SEMICONDUCTOR TM **TO-92 Packaging** Configuration: Figure 1.0 **TAPE and REEL OPTION** FSCINT Label sample See Fig 2.0 for various Reeling Styles CBVK//418019 **FSCINT** Label 5 Reels per Intermediate Box Customized F63TNR Label sample Label F63TNR LOT: CBVK741B019 QTY: 2000 FSID: PN222N Customized QTY1: QTY2: 375mm x 267mm x 375mm Intermediate Box TO-92 TNR/AMMO PACKING INFROMATION **AMMO PACK OPTION** See Fig 3.0 for 2 Ammo Packing Style Quantity EOL code **Pack Options** 2,000 D26Z Е 2,000 D27Z Ammo М 2,000 D74Z 2,000 D75Z **FSCINT** Unit weight = 0.22 gm Reel weight with components = 1.04 kg Ammo weight with components = 1.02 kg Max quantity per intermediate box = 10,000 units Label 5 Ammo boxes per Intermediate Box 327mm x 158mm x 135mm Immediate Box Customized F63TNR Customized Label Label 333mm x 231mm x 183mm Intermediate Box (TO-92) BULK PACKING INFORMATION **BULK OPTION** See Bulk Packing DESCRIPTION QUANTITY Information table J18Z TO-18 OPTION STD 2.0 K / BOX Anti-static Bubble Sheets TO-5 OPTION STD NO LEAD CLIP 1.5 K / BOX J05Z **FSCINT Label** NO EOL TO-92 STANDARD STRAIGHT FOR: PKG 92, NO LEADCLIP 2.0 K / BOX 94 (NON PROELECTRON SERIES), 96 TO-92 STANDARD STRAIGHT FOR: PKG 94 (PROELECTRON SERIES BCXXX, BFXXX, BSRXXX), 97, 98 L34Z NO LEADCLIP 2.0 K / BOX 2000 units per 114mm x 102mm x 51mm EO70 box for std option Immediate Box 5 EO70 boxes per intermediate Box 530mm x 130mm x 83mm Customized Intermediate box Label FSCINT Label 10,000 units maximum per intermediate box for std option

TO-92 Tape and Reel Data and Package Dimensions, continued

TO-92 Reeling Style Configuration: Figure 2.0

Machine Option "A" (H)

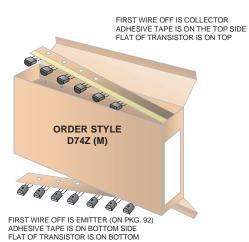


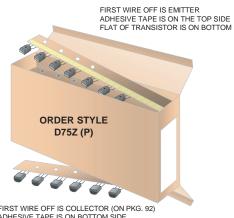
Style "A", D26Z, D70Z (s/h)

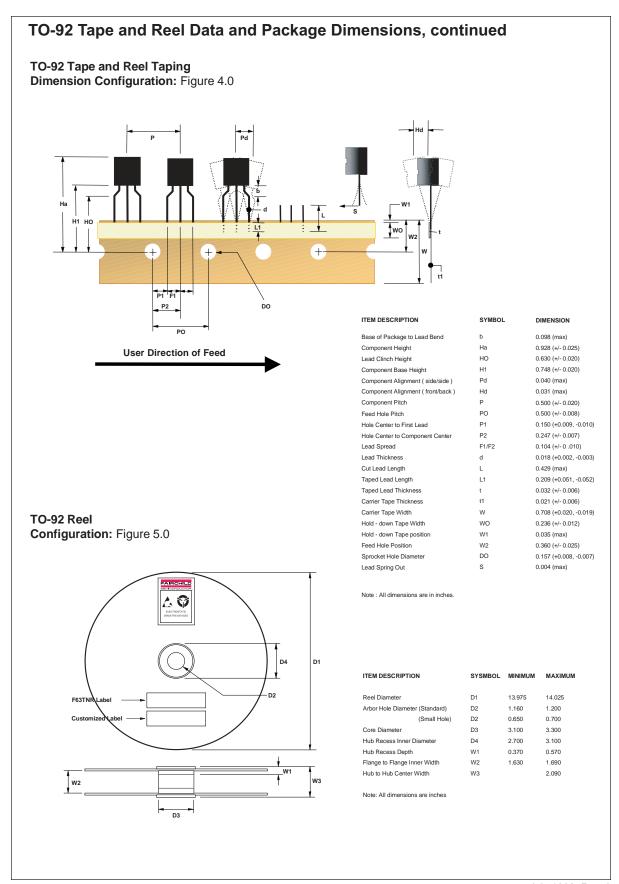
Machine Option "E" (J)

Style "E", D27Z, D71Z (s/h)

TO-92 Radial Ammo Packaging Configuration: Figure 3.0







TO-92 Tape and Reel Data and Package Dimensions TO-92 (FS PKG Code 92, 94, 96) Scale 1:1 on letter size paper Dimensions shown below are in: inches [millimeters] Part Weight per unit (gram): 0.1977 TO-92 (92,94,96) 96 94 В В 0.76 В G Ε Ø0.060 [Ø1.52] 0.010 [0.254] DEEP В S С 0.615 0.570 5.0°TYP.

January 2000, Rev. B

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No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
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